

VDS	RDS(on)	ID@25℃
650V	60mΩ	29A

Applications:

- Solar Inverters
- Switch Mode Power Supplies
- High Voltage DC/DC Converters
- EV Charging
- Motor Drives

Features:

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitances
- Easy to Parallel and Simple to Drive
- Avalanche Ruggedness

Benefits:

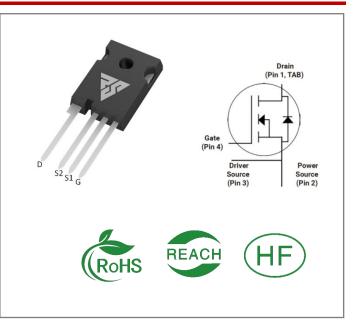
- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

Ordering Information

Part Number	Package	Marking	Packing	Qty.
RSM065060Z	TO-247-4	RSM065060Z	Tube	30 PCS

Maximum Ratings (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
VDSmax	Drain - Source Voltage	650	V VGS=0V,ID =100μA		
VGSmax	Gate - Source Voltage	-8/+20	V Absolute maximum values		
VGSop	Gate - Source Voltage	-4/+18	V Recommended operational values		
ID	Continuous Drain Current	29 20	А	VGS=18V, TC =25℃ VGS=18V, TC =100℃	
ID(pulse)	Pulsed Drain Current	99	А	Pulse width tp limited by TJmax	
PD	Power Dissipation	150	W	TC =25℃, TJ =175℃	
TL	Solder Temperature	260	°C		
TJ, Tstg	Operating Junction and StorageTemperature	-40 to + 175	°C		





Electrical Characteristics (TJ= 25° C unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note	
V(BR)D SS	Drain-Source Breakdown Voltage	650			V	VGS=0V,ID =100µA		
	Gate Threshold	1.8	2.6	4.0	V	VGS= VDS, IDS=5mA,TC =25℃		
VGS(th) Volt	Voltage		1.8		V	VGS= VDS, IDS=5mA,TC =175℃		
IDSS	Zero Gate Voltage Drain Current		1	50	μΑ	VDS= 650V, VGS=0V		
IGSS	Gate-Source Leakage Current		10	250	nA	VGS=18V, VDS= 0V		
	Drain-Source on-state		60	79	mΩ	VGS=18V, ID =13.2A, TC =25℃		
RDS(on)	Resistance		75			VGS=18V, ID =13.2A, TC =175℃		
Ciss	Input Capacitance		830			VGS=0V, VDS=400 V,		
Coss	Output Capacitance		82		pF	f=1MHz, VAC=25 mV		
Crss	Reverse Transfer Capacitance		14					
EON	Turn-On Switching Energy		140		μ	VDS =400V, VGS =-4/18V,ID = 13.2A,		
EOFF	Turn-Off Energy		52			RG(ext) = 2.5Ω, L= 200μH		
td(on)	Turn-On Delay Time		8					
tr	Rise Time		9			VDS =400V, VGS =-4/18 V		
td(off)	Turn-Off Delay Time		21		ns	ID = 13.2A, RG(ext) =2. 5 Ω , RL =30Ω		
tf	Fall Time		8					
RG(int)	Internal Gate Resistance		6		Ω	f=1 MHz, VAC=25mV		
Qgs	Gate to Source Charge		13		nC	VDS=400V, VGS=-4/18V ID = 13.2A		
Qgd	Gate to Drain Charge		12		nC			
Qg	Total Gate Charge		50					



Reverse Diode Characteristics (TJ= 25° C unless otherwise specified)

Symbol	Parameter	Тур.	Max	Unit	Test Conditions	Note
		4.2		V	VGS=-4V, ISD = 6.6 A, TJ = 25℃	
VSD	Diode Forward Voltage	Ŭ		V	VGS=-4V, ISD= 6.6 A, TJ= 175℃	
IS	Continuous Diode Forward Current		23	A VGS=-4V,TC= 25℃		
trr	Reverse Recovery time	28		ns		
Qrr	Reverse Recovery Charge	47		nC	ISD= 13.2 A, VR = 400V	
Irrm	Peak Reverse Recovery Current	3		A		

Thermal Characteristics (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Тур.	Unit	Test Conditions	Note
RθJC	Thermal Resistance from Junction to Case	0.99	°C/W		
RθJA	Thermal Resistance From Junction to Ambient	40			

Typical Feature Curve

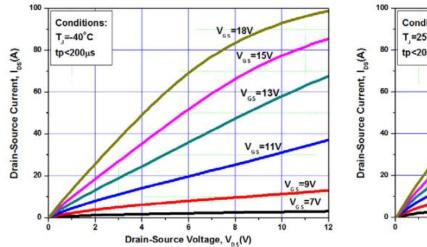


Figure 1. Output Characteristics T_J = -40 °C

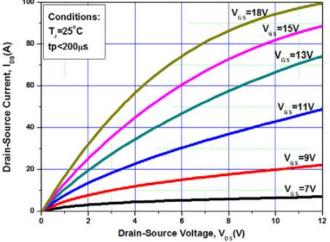


Figure 2. Output Characteristics T_J = 25℃

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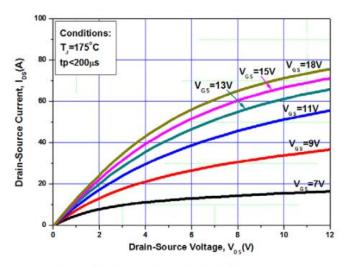
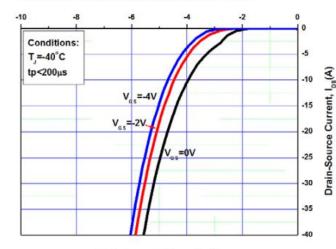


Figure 3. Output Characteristics T₁ = 175°C



Drain-Source Voltage, V_{Ds}(V)

Figure 5. Body Diode Characteristic at -40℃

V_{gs}=-4V

=0V

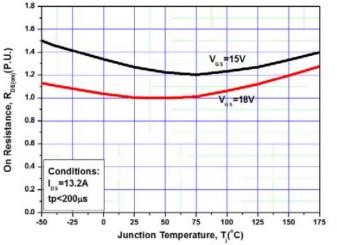
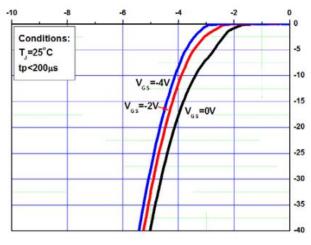


Figure 4. Normalized On-Resistance vs. Temperature



Drain-Source Voltage, V_{DS}(V)

Figure 6. Body Diode Characteristic at 25℃

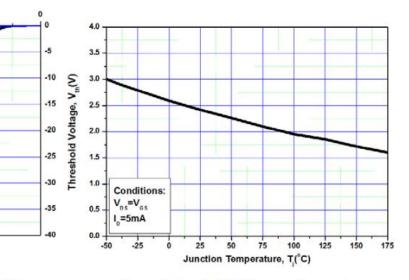


Figure 7. Body Diode Characteristic at 175℃

Drain-Source Voltage, V_{DS}(V)

Figure 8. Threshold Voltage vs. Temperature

Drain-Source Current, I_{0s}(A)

-10

Drain-Source Current, I_{Ds}(A)

-8

Conditions:

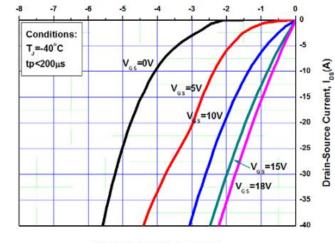
T,=175°C

tp<200µs

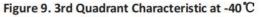
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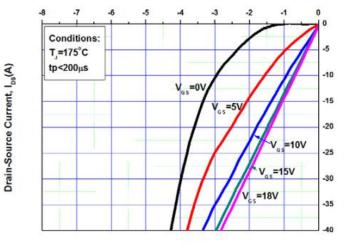


Drain-Source Current, I_{Ds}(A)



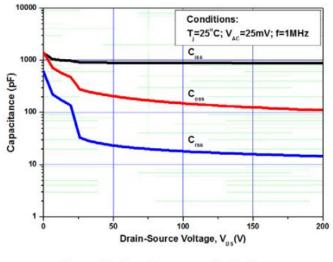
Drain-Source Voltage, V_{DS}(V)

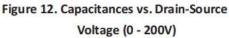




Drain-Source Voltage, Vps(V)

Figure 11. 3rd Quadrant Characteristic at 175℃





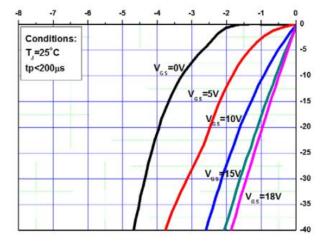
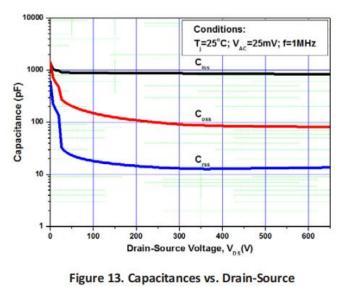




Figure 10. 3rd Quadrant Characteristic at 25 °C

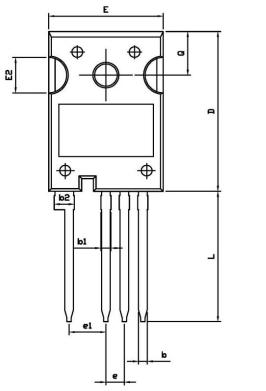


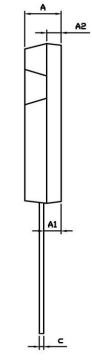
Voltage (0 - 650V)

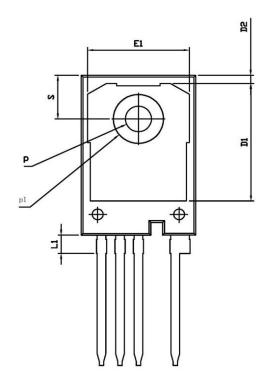
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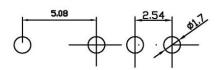
Package outline drawing(TO-247-4 Unit: mm)







RECOMMENDED LAND PATTERN



UNIT: mm

	MIN	NOM	MAX
А	4.80	5.00	5.20
A1	2.25	2.40	2.45
A2	1.85	2.00	2.15
b	1.05	1.20	1.35
b1	1.00	1.30	1.60
b2	2.35	2.65	2.95
с	0.50	0.60	0.70
D	22.34	22.54	22.74
D1	16.00	16.50	17.00
D2	0.97	1.17	1.37
е	2.34	2.54	2.74
e1	4.88	5.08	5.28
E	15.60	15.80	16.00
E1	13.50	14.00	14.50
E2	4.80	5.00	5.20
L	18.08	18.38	18.68
L1	2.38	2.58	2.78
р	3.50	3.60	3.70
p1	6.60	6.80	7.00
Q	6.00	6.15	6.30
S	6.00	6.15	6.30



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